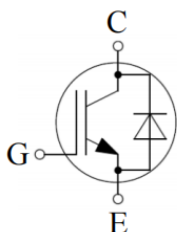




IGBT Discrete

V_{CE}	1200	V
I_C	75	A
$V_{CE(SAT)} I_C=75A$	1.60	V

Circuit



Applications

- Inverter for motor drive
- Three-level Solar String Inverter
- Motor controller

Features

- High breakdown voltage to 1200V for improved reliability
- Maximum junction temperature 175°C
- Positive temperature coefficient
- Including fast & soft recovery anti-parallel FWD
- High short circuit capability(10us)

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V_{CE}	1200	V
DC Collector Current, limited by T_{jmax} $T_C=25^{\circ}C$ $T_C=100^{\circ}C$	I_C	150 75	A
Diode Forward Current, limited by T_{jmax} $T_C=25^{\circ}C$ $T_C=100^{\circ}C$	I_F	150 75	A
Continuous Gate-Emitter Voltage	V_{GE}	± 20	V
Transient Gate-Emitter Voltage ($tp \leq 10\mu s, D < 0.010$)	V_{GE}	± 30	V
Turn off Safe Operating Area $V_{CE} \leq 1200V$, $T_j \leq 150^{\circ}C$		300	A
Pulsed Collector Current, $V_{GE}=15V$, tp limited by T_{jmax}	I_{CM}	300	A
Diode Pulsed Current, tp limited by T_{jmax}	I_{Fpuls}	300	A
Short Circuit Withstand Time, $V_{GE}=15V, V_{CC}=600V, V_{CEM} \leq 1200V$	T_{sc}	10	μs
Power Dissipation, $T_j=175^{\circ}C, T_C=25^{\circ}C$	P_{tot}	555	W



Operating Junction Temperature	T_j	-40...+175	°C
Storage Temperature	T_s	-55...+150	°C
Soldering Temperature, wave soldering 1.6mm (0.063in.) from case for 10s		260	°C

Electrical Characteristics of the IGBT ($T_j = 25^\circ\text{C}$ unless otherwise specified):

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Collector-Emitter Breakdown Voltage	BV_{CES}	$V_{GE}=0V, I_C=250\mu A$	1200		-	V
Gate Threshold Voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=2.8mA$	5.0	5.8	6.5	V
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=75A$ $T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$ $T_j=150^\circ\text{C}$	1.30	1.60 1.90 2.00	1.90	V
Zero Gate Voltage Collector Current	I_{CES}	$V_{CE}=1200V, V_{GE}=0V$ $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			0.25 5	mA
Gate-Emitter Leakage Current	I_{GES}	$V_{CE}=0V, V_{GE}=\pm 20V$			100	nA

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic						
Input Capacitance	C_{ies}	$V_{CE}=25V, V_{GE}=0V,$ $f=1MHz$	-	10.02	-	nF
Reverse Transfer Capacitance	C_{res}		-	0.15	-	
Gate Charge	Q_G	$V_{CC}=960V, I_C=75A,$ $V_{GE}=15V$	-	1.05	-	uC

**Electrical Characteristics of the Diode** ($T_j = 25^\circ\text{C}$ unless otherwise specified):

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Diode Forward Voltage	V_F	$I_F = 75\text{A}$ $T_j = 25^\circ\text{C}$, $T_j = 125^\circ\text{C}$ $T_j = 150^\circ\text{C}$		2.00 1.90 1.80	2.60	V

Switching Characteristic, Inductive Load

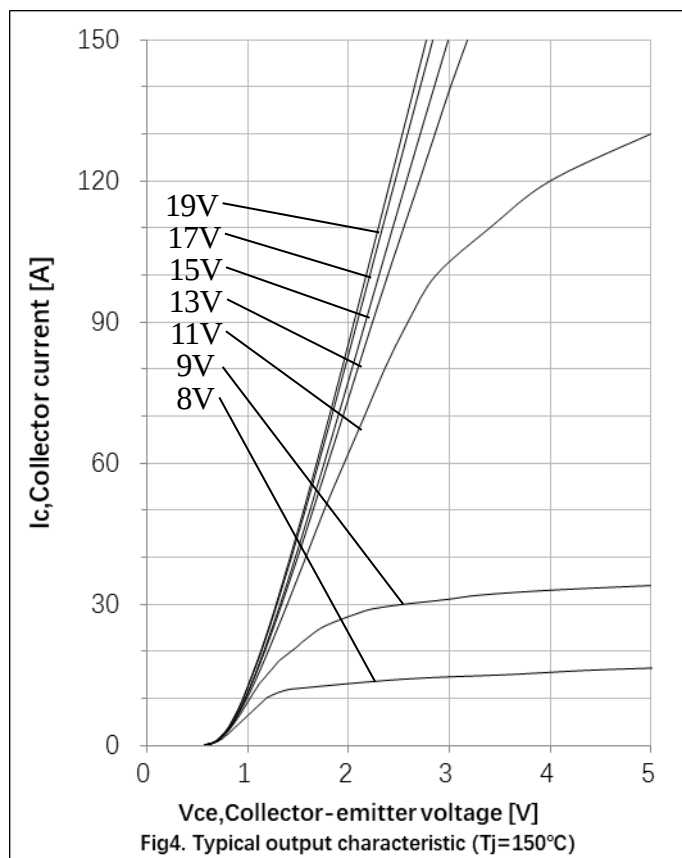
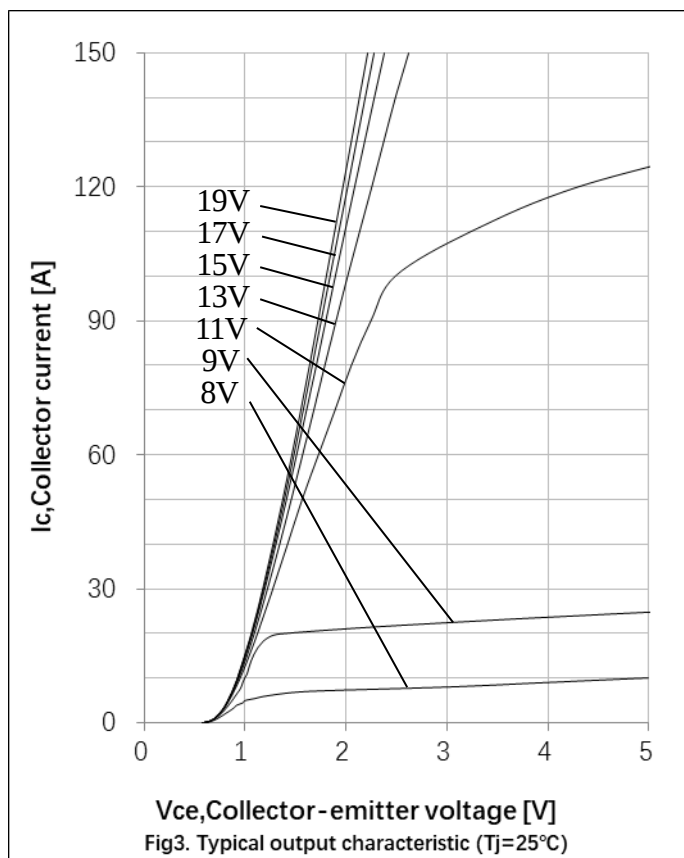
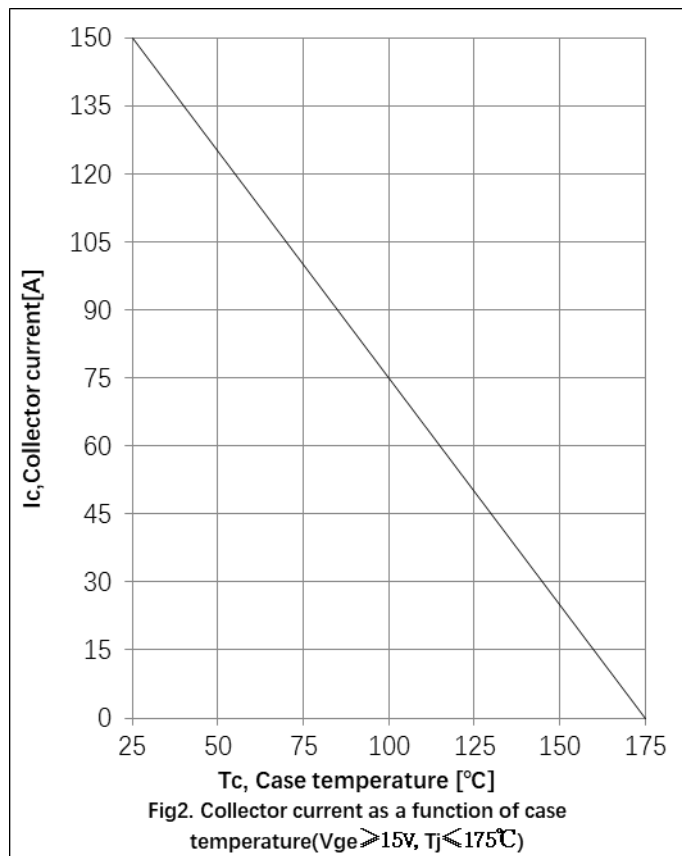
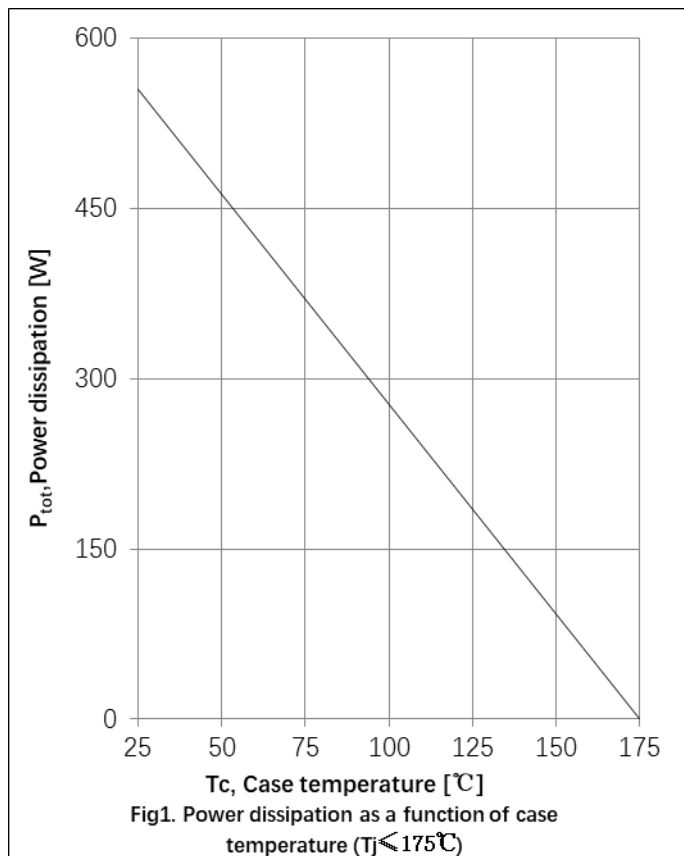
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic , at T _j = 25 °C						
Turn-on Delay Time	t _{d(on)}	V _{CC} = 600V, I _C =75A, V _{GE} = -5V~15V, R _g =10Ω	-	20	-	ns
Rise Time	t _r		-	102	-	ns
Turn-on Energy	E _{on}		-	12.6	-	mJ
Turn-off Delay Time	t _{d(off)}		-	375	-	ns
Fall Time	t _f		-	355	-	ns
Turn-off Energy	E _{off}		-	6.9	-	mJ
Dynamic , at T _j = 125 °C						
Turn-on Delay Time	t _{d(on)}	V _{CC} = 600V, I _C =75A, V _{GE} = -5V~15V, R _g =10Ω	-	21	-	ns
Rise Time	t _r		-	105	-	ns
Turn-on Energy	E _{on}		-	12.9	-	mJ
Turn-off Delay Time	t _{d(off)}		-	444	-	ns
Fall Time	t _f		-	522	-	ns
Turn-off Energy	E _{off}		-	9.7	-	mJ
Dynamic , at T _j = 150 °C						
Turn-on Delay Time	t _{d(on)}	V _{CC} = 600V, I _C =75A, V _{GE} = -5V~15V, R _g =10Ω	-	21	-	ns
Rise Time	t _r		-	111	-	ns
Turn-on Energy	E _{on}		-	13.2	-	mJ
Turn-off Delay Time	t _{d(off)}		-	468	-	ns
Fall Time	t _f		-	598	-	ns
Turn-off Energy	E _{off}		-	10.3	-	mJ

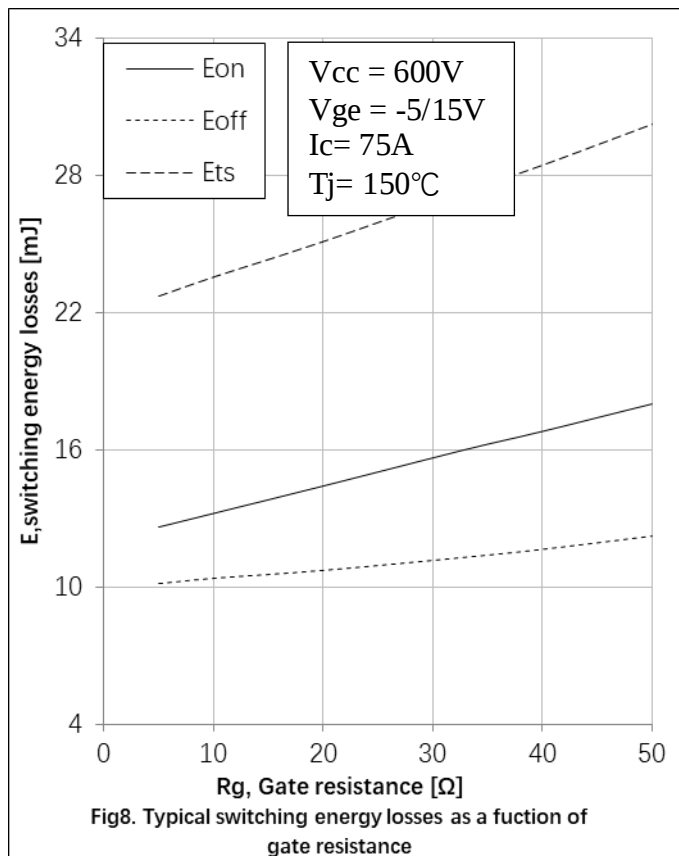
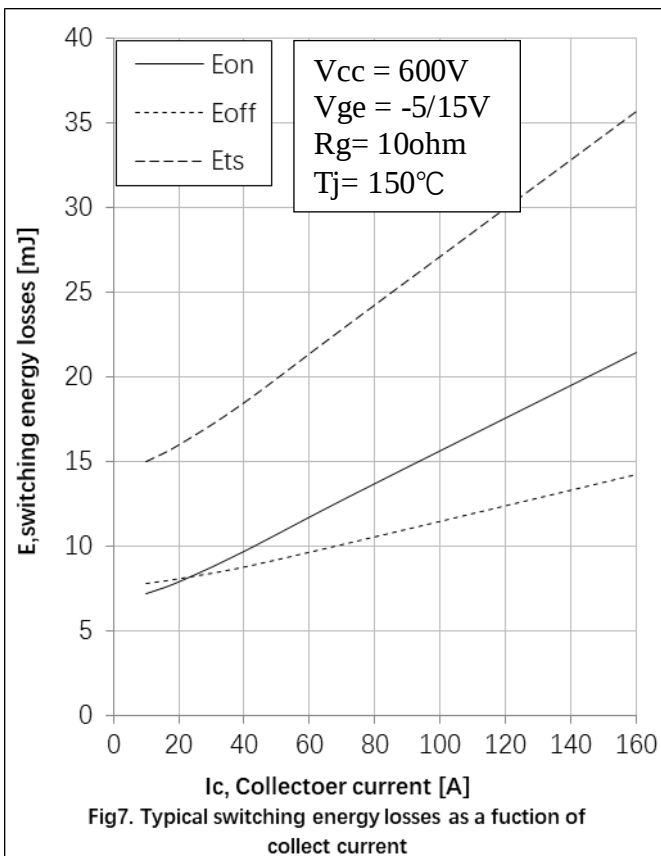
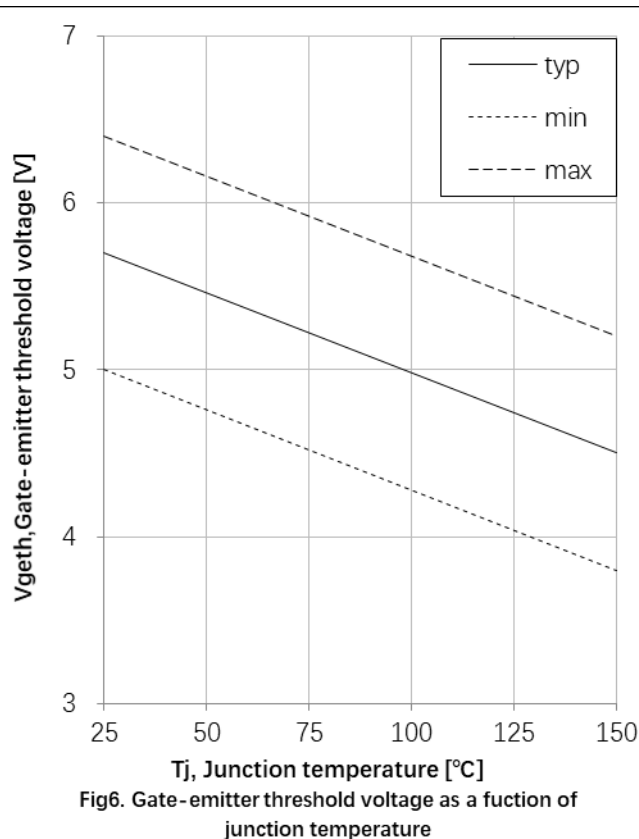
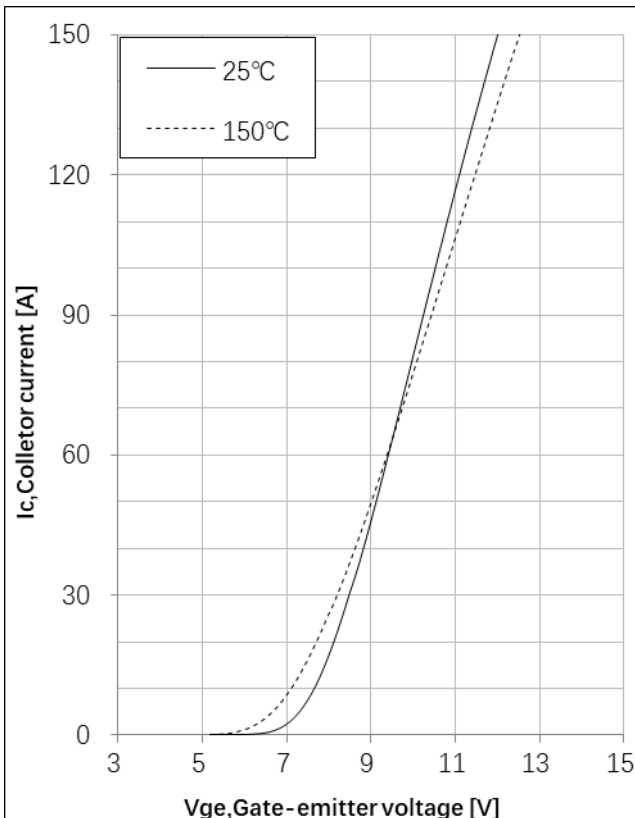
**Electrical Characteristics of the DIODE**

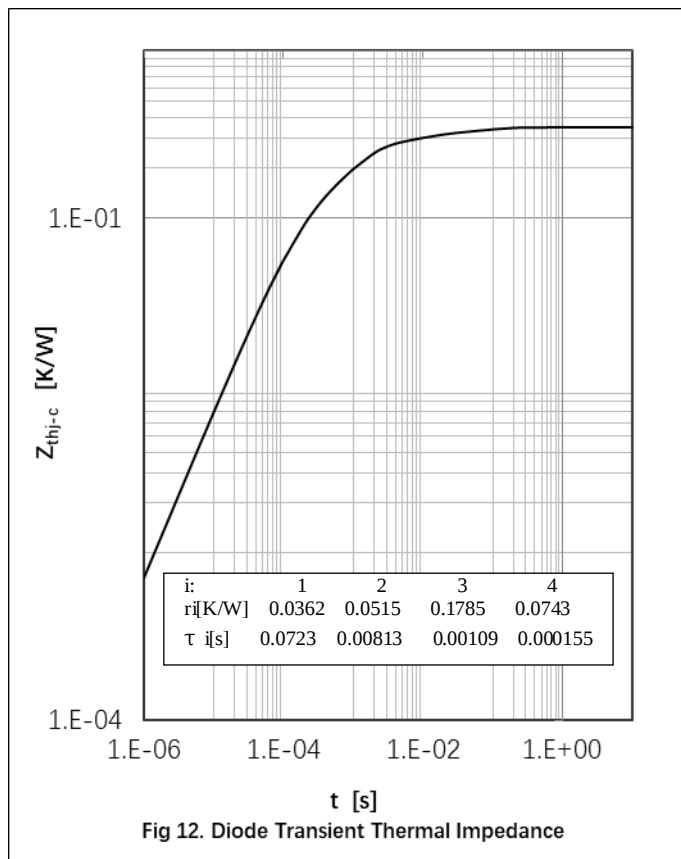
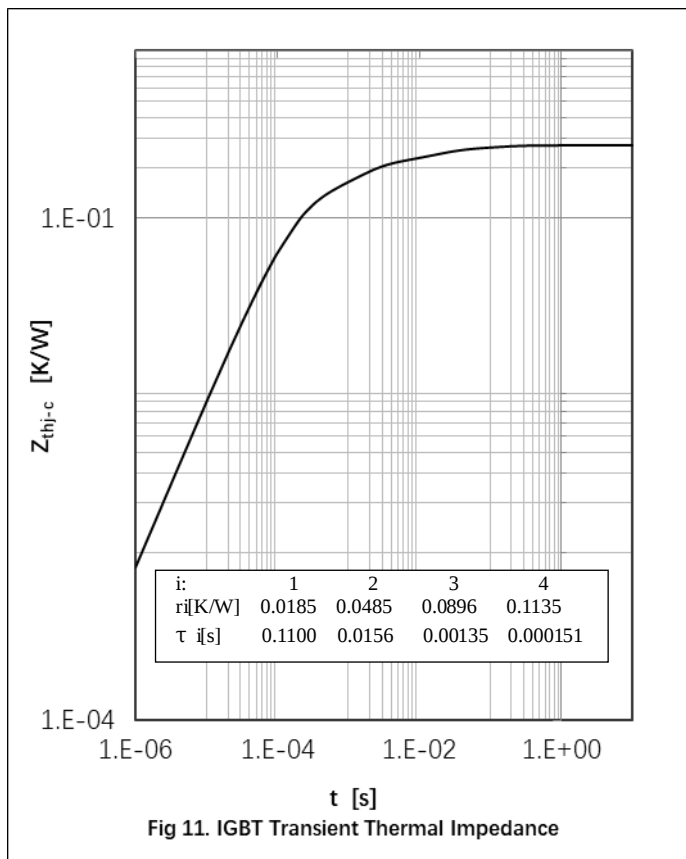
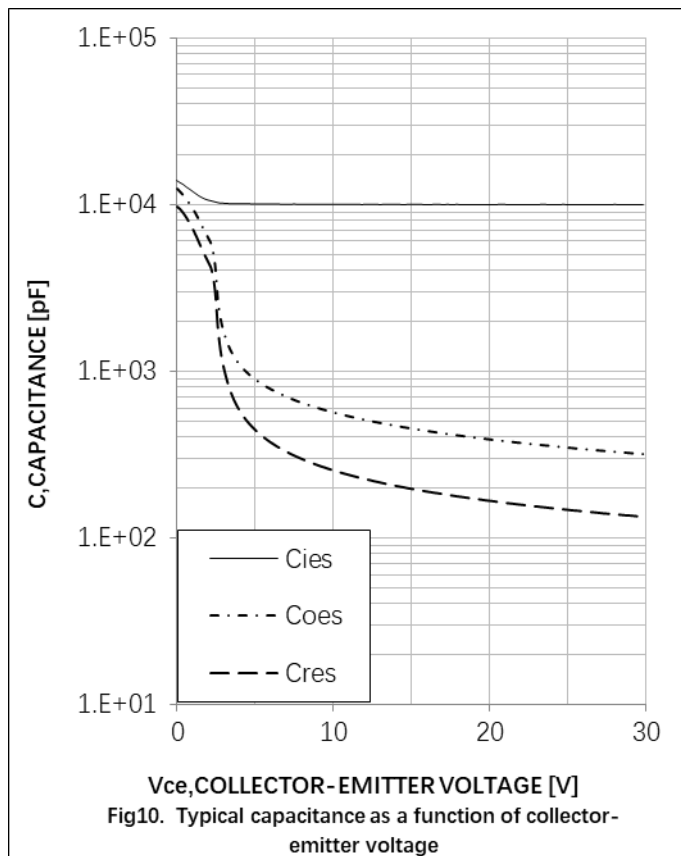
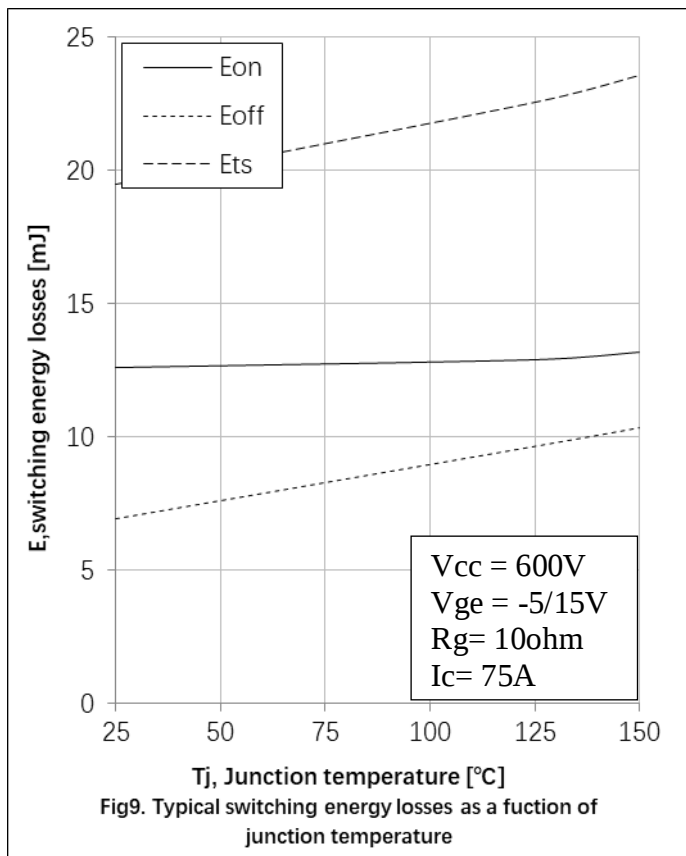
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic , at T _j = 25°C						
Reverse Recovery Current	I _{rr}	I _F =75A, V _R =600V, di/dt= -500A/μs	-	9	-	A
Diode reverse recovery time	trr		-	268	-	ns
Reverse Recovery Charge	Q _{rr}		-	3.42	-	uC
Reverse Recovery Energy	E _{rec}		-	1.52	-	mJ
Dynamic , at T _j = 125°C						
Reverse Recovery Current	I _{rr}	I _F =75A, V _R =600V, di/dt= -500A/μs	-	12	-	A
Diode reverse recovery time	trr		-	337	-	ns
Reverse Recovery Charge	Q _{rr}		-	6.58	-	uC
Reverse Recovery Energy	E _{rec}		-	3.18	-	mJ
Dynamic , at T _j = 150°C						
Reverse Recovery Current	I _{rr}	I _F =75A, V _R =600V, di/dt= -500A/μs	-	14	-	A
Diode reverse recovery time	trr		-	375	-	ns
Reverse Recovery Charge	Q _{rr}		-	9.45	-	uC
Reverse Recovery Energy	E _{rec}		-	3.73	-	mJ

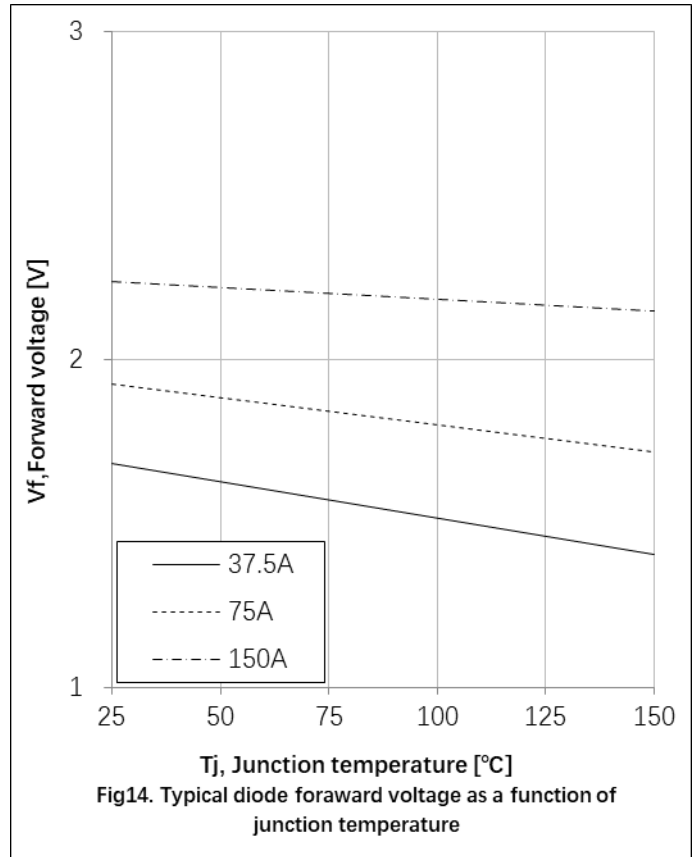
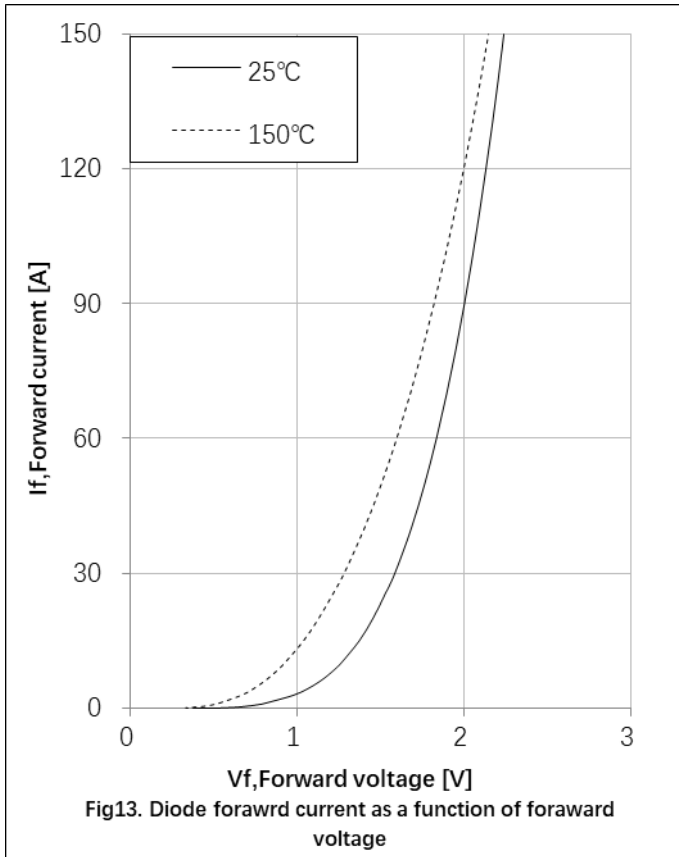
Thermal Resistance

Parameter	Symbol	Max. Value	Unit
IGBT Thermal Resistance, Junction - Case	R _{th(j-c)}	0.27	K/W
Diode Thermal Resistance, Junction - Case	R _{th(j-c)}	0.35	K/W
Thermal Resistance, Junction - Ambient	R _{th(j-a)}	40	K/W

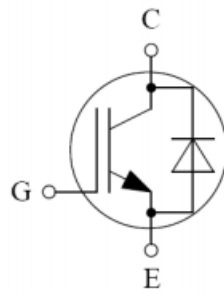






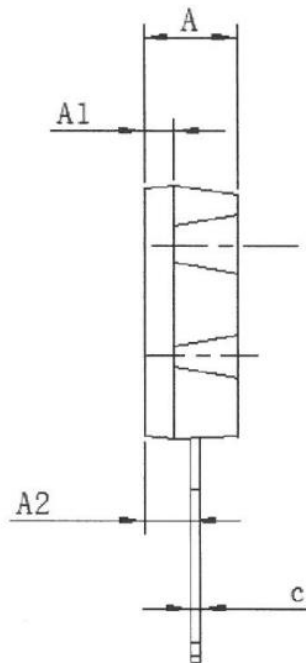
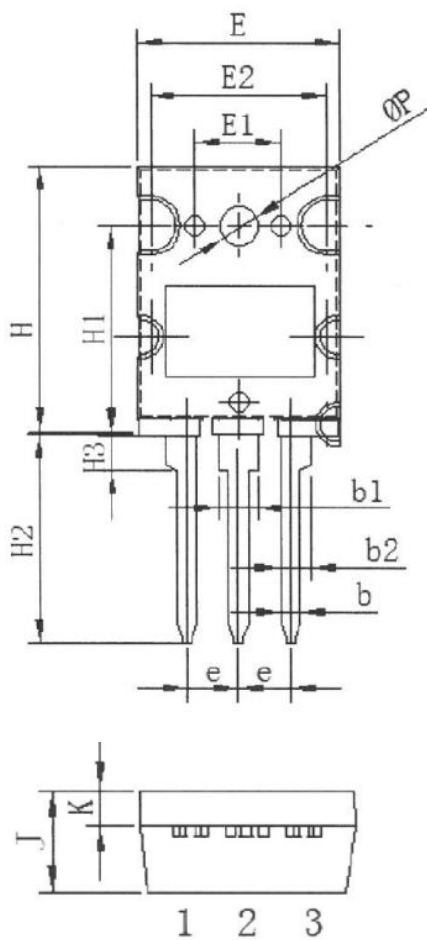


● Circuit Diagram



● Package Outline Information

CASE: TO 264



To-264		
Dim	Min	Max
A	4.80	5.20
A1	1.80	2.20
A2	3.20	3.60
b	0.80	1.20
b1	2.90	3.30
b2	2.40	2.80
C	0.50	0.70
e	5.25	5.65
E	19.8	20.2
E1	17.6	18.0
E2	8.60	9.00
H	25.8	26.2
H1	19.8	20.2
H2	19.8	20.8
H3	2.00	3.00
G	6.00	6.40
φP	3.00	3.40
J	4.80	5.20
K	1.30	1.70